

Dear Customer,

Please find attached our INFINEON Technologies PCN:

Transfer of wafer fab from Newport, Wales to Silicon Foundry

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **22-August-2016**.
- Infineon aligns with the widely-recognized JEDEC STANDARD “**JESD46**“, which stipulates:
“**Lack of acknowledgment of the PCN within 30 days constitutes acceptance of the change.**”

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG
Postal Address Headquarters: Am Campeon 1-12, D-85579 Neubiberg, Phone +49 (0)89 234-0
Chairman of the Supervisory Board: Wolfgang Mayrhuber
Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck
Registered Office: Neubiberg Commercial Register
Amtsgericht München HRB 126492

Transfer of wafer fab from Newport, Wales to Silicon Foundry

► Products affected:

See attached for affected parts.

► Detailed Change Information:

Subject: Transfer of wafer fab from Newport, Wales to Silicon Foundry

Reason: As part of a manufacturing consolidation plan announced in March 2015, Infineon indicated that it would be closing the Wales Fab facility and transferring the production capability for certain parts to foundries.

Description: Transfer of wafer fab from Newport, Wales to Silicon Foundry

Site	Old	New
Fab	IFX Newport Wales Fab	TowerJazz
Material		
Passivation	Epoxy Passivation	Polyimide Passivation

► Product Identification:

Wafer fab origins will not be distinguished through the external part marking or shipping labels, however, based on the assembly lot code and marked on the device. IFX internal systems will be able to trace the site of the wafer lots used to produce the final product.

► Impact of Change:

No changes to form, fit, or function. The package outline remains the same. Datasheet specifications will not be changed. The package bill of material and the location for assembly and final test will not change.

► Attachments:

916-DISTI42-C4002348_AffectedParts.xlsx

► Time Schedule:

- Final qualification report:
- First samples available:
- Intended start of delivery:

Available

On request

02-September-2016

If you have any questions, please do not hesitate to contact your local Sales office.

PCN N° 916-DISTI42-C4002348-Private
Transfer of wafer fab from Newport, Wales to Silicon Foundry



Sales Name	SP number	OPN	Package
AUIRFS8405	SP001522864	AUIRFS8405	D2PAK
AUIRFSL8405	SP001522846	AUIRFSL8405	TO262
AUIRFU8405	SP001516840	AUIRFU8405	IPAK
AUIRFR8403	SP001517580	AUIRFR8403	DPAK
AUIRFS8407	SP001520236	AUIRFS8407	D2PAK
AUIRFU8403	SP001518276	AUIRFU8403	IPAK
AUIRFB8407	SP001517430	AUIRFB8407	TO220
AUIRFS8409	SP001517498	AUIRFS8409	D2PAK
AUIRFSL8407	SP001517488	AUIRFSL8407	TO262
AUIRFSL8409	SP001516096	AUIRFSL8409	TO262
AUIRFS8403	SP001518060	AUIRFS8403	D2PAK
AUIRFSL8403	SP001520686	AUIRFSL8403	TO262
AUIRFU8401	SP001518756	AUIRFU8401	IPAK
AUIRFB8405	SP001516720	AUIRFB8405	TO220
AUIRFB8409	SP001521544	AUIRFB8409	TO220